

What is claimed is:

1. A semiconductor memory device comprising:

a memory cell array including a plurality of memory cells connected between a plurality of word lines and a plurality of bit line pairs;

a predetermined number of write line pairs;

a predetermined number of read line paris;

a plurality of write column selection gates for transmitting data between the plurality of bit line pairs and the predetermined number of write line pairs during a write operation; and

a plurality of read column selection gates for transmitting data between the plurality of bit line pairs and the predetermined number of read line pairs in response to a read operation.

2. The semiconductor memory device according to claim 1, further comprising a command decoder for decoding externally input command signals and generating a write command for the write operation and a read command for the read operation.

3. The semiconductor memory device according to claim 2, wherein the command decoder further decodes the command signals to generate write and read commands for performing the write and read operations simultaneously.

4. A semiconductor memory device comprising:

a memory cell array including a plurality of memory cell array blocks each including a plurality of memory cells connected between a plurality of word lines and a plurality of bit line pairs;

a predetermined number of local write line pairs of each of the plurality of memory cell array blocks for inputting data in each of the plurality of memory cell array blocks;

a predetermined number of local read line pairs of each of the plurality of memory cell array blocks for outputting data of each of the plurality of memory cell array blocks;

a plurality of write column selection gates of each of the plurality of memory cell array blocks for transmitting data between the plurality of bit line pairs and the predetermined number of local write line pairs during a write operation;

read column selection gates of each of the plurality of memory cell array blocks for transmitting data between the plurality of bit line pairs and the predetermined number of local read line pairs during a read operation;

a predetermined number of global write line pairs connected to the predetermined number of local write line pairs of each of the plurality of memory cell array blocks; and

a predetermined number of global read line pairs connected to the predetermined number of local read line pairs of each of the plurality of memory cell array blocks.

5. The semiconductor memory device according to claim 4, further comprising a command decoder for decoding externally input command signals and generating a write command for the write operation and a read command for the read operation.

6. The semiconductor memory device according to claim 5, wherein the command decoder further generates write and read commands for performing the write and the read operations simultaneously after decoding the commands.

7. The semiconductor memory device according to claim 4, further comprising:

a first switch for transmitting data input through a predetermined number of data input pads to the predetermined number of global line pairs in response to a control signal, and outputting data transmitted from the predetermined number of global read line pairs to a predetermined number of data output pads; and

a second switch for transmitting data input through the predetermined number of data output pads to the predetermined number of global line pairs in response to an inverted signal of the control signal, and outputting data transmitted from the predetermined number of global read line pairs to the predetermined number of data input pads.

8. A semiconductor memory device comprising:

a memory cell array including a plurality of memory cell array blocks each including a plurality of memory cells connected between a plurality of word lines and a plurality of bit line pairs;

a predetermined number of local write line pairs of each of the plurality of memory cell array blocks for inputting data in each of the plurality of memory cell array blocks;

a predetermined number of local read line pairs of each of the plurality of memory cell array blocks for outputting data of each of the plurality of memory cell array blocks;

a plurality of write column selection gates of each of the plurality of memory cell array blocks for transmitting data between the plurality of bit line pairs and the predetermined number of local write line pairs during a write operation;

read column selection gates of each of the plurality of memory cell array blocks for transmitting data between the plurality of bit line pairs and the predetermined number of local read line pairs during a read operation;

a write column decoder for generating write column selection signals to select a predetermined number of write column selection gates among the plurality of write column selection gates by inputting a column address during the write operation;

a read column decoder for generating read column selection signals to select a predetermined number of read column selection gates among the plurality of read column selection gates by inputting the column address during the read operation;

a predetermined number of global write line pairs connected to a predetermined number of local write line pairs of each of the plurality of memory cell array blocks;

a predetermined number of global read line pairs connected to a predetermined number of local read line pairs of each of the plurality of memory cell array blocks;

a data input circuit for transmitting data input to a predetermined number of data input pads to the predetermined number of global write line pairs;

a data output circuit for outputting data transmitted from the predetermined number of global read line pairs to a predetermined number of data output pads; and

a command decoder for decoding externally input command signals and generating a write command for the write operation and a read instruction for the read operation.

9. The semiconductor memory device according to claim 8, wherein the command decoder decodes the command signals and further generates the write and the read commands for performing the write and the read operations simulataneously.

10. The semiconductor memory device according to claim 8, further comprising:

a first switch for transmitting data input to a predetermined number of data input pads to the data input circuit in response to a control signal, and transmitting data transmitted from the data output circuit to a predetermined number of data output pads; and

a second switch for transmitting data input through the predetermined number of data output pads to the data input circuit in response to an inverted signal of the control signal, and transmitting data output from the data output circuit to the predetermined number of data input pads.

11. A method for writing and reading data to and from a semiconductor memory device comprising the steps of:

transmitting data input through a first pad to a write line pair during a write operation, and data output from a memory cell array to a read line pair during a read operation; and

transmitting data transmitted to the write line pair to the memory cell array during a write operation, and outputting data transmitted to the read line pair through a second pad during a read operation.

12. The method according to claim 11, wherein the write operation and the read operation are performed independently.

13. The method according to claim 11, wherein the write operation and the read operation are performed simultaneously.

14. A method for writing and reading data to and from a semiconductor memory device comprising the steps of:

transmitting data input through a data input (output) pad to a global write line pair during a write operation, and transmitting data stored in a memory cell array to a local read line pair during a read operation;

transmitting data transmitted to the global write line pair to a local write line pair during a write operation, and transmitting data transmitted to the local read line pair to a global read line pair during a read operation; and

transmitting data transmitted to the local write line pair to the memory cell array during a write operation, and transmitting data transmitted to the global read line pair to a local read line pair and outputting data transmitted to the local read line pair through a data output (input) pad during a read operation.

15. The method according to claim 14, wherein the write operation and the read operation are performed independently.

16. The method according to claim 14, wherein the write operation and the read operation are performed simultaneously.